



DATA SHEET

SNAP Engine SM220 Series

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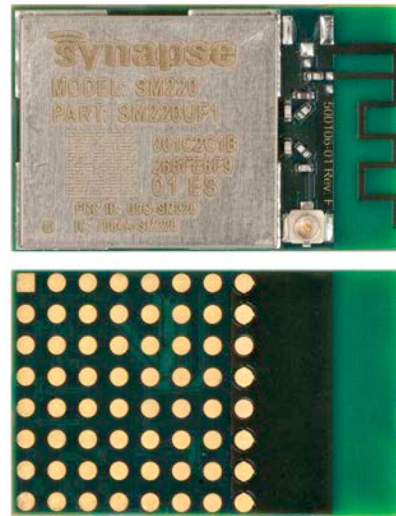
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6723 Odyssey Drive // Huntsville, AL 35806 // (877) 982-7888 // Synapse-Wireless.com

SNAP Engine SM220 Modules Overview

The SNAP Engine Model SM220 series currently consists of the SM220UF1. It is an IEEE 802.15.4, low-power, highly reliable solution for embedded wireless control and monitoring networks that require high data rates. The Model SM220 embeds Synapse's SNAP OS, the industry's first Internet-enabled, wireless mesh network operating system, into the Atmel ATmega128RFA1 single-chip AVR® microcontroller with an integrated transceiver that delivers up to 2Mbits/sec. This low-cost module can have current consumption under 390nA to enable a new generation of battery-driven systems. The SM220 also includes a Skyworks SE2431L front-end module, which provides a power amplifier and LNA for increased range.

SNAP's on-board Python interpreter provides for rapid application development and over-the-air programming, while Atmel's low-power RF single-chip design saves board space and lowers power consumption. The modules provide up to 15 channels of operation in the ISM 2.4GHz frequency band.



This data sheet covers part number SM220UF1:

- 32 GPIO with up to 7 A/D inputs
- 128k flash, 58.5k free for over-the-air uploaded user apps
- Two UART ports for control or transparent data
- Low power modes:
 - Timed Sleep Mode 1 : 1.27 μ A
 - Timed Sleep Mode 2 : 1.47 μ A
 - Untimed Sleep Mode : < 390 nA
- Spread Spectrum (DSSS) technology
- Up to 2 Mbps radio data rate
- 2.4 GHz RF Frequency
- AES 128-bit encryption
- Integrated on-board compact F antenna or U.FL connector
- Surface Mount, Solder-able
- 4K internal EEPROM
- 8 PWM outputs
- Supports over the air firmware upgrades.
(This process is further defined in the Portal users guide.)

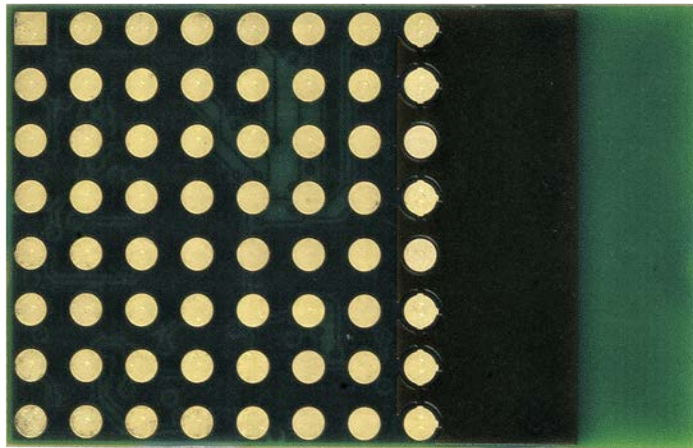
SM220 – Surface Mount Module

The SM220 is a surface mount module based on the ATmega128RFA1 chip. All the details appropriate for the chip-based version of ATmega128RFA1 SNAP apply to the SM220, with the following additions and exceptions. Pin numbers below refer to the pad on the SM220 footprint, with a 64-pin arrangement of eight rows ("A" through "H") by eight columns ("1" - "8"). To reference IO pins in your code, use the SNAPpy IO number from Table 3.

Form Factor

The SM220 is not in the "SNAP Engine" thru-hole form factor. It is in a surface mount form-factor. As such, it technically doesn't have "pins," it has "pads." Looking at the bottom of the module (the side with the pads), the pad arrangement is as shown in the following table.

A1	A2	A3	A4	A5	A6	A7	A8
B1	B2	B3	B4	B5	B6	B7	B8
C1	C2	C3	C4	C5	C6	C7	C8
D1	D2	D3	D4	D5	D6	D7	D8
E1	E2	E3	E4	E5	E6	E7	E8
F1	F2	F3	F4	F5	F6	F7	F8
G1	G2	G3	G4	G5	G6	G7	G8
H1	H2	H3	H4	H5	H6	H7	H8



The pad designators "A1" through "H8" will be used throughout the remainder of this document.

Specifications

Table 1: SM220 Specifications at 23° C and 3.3V unless otherwise noted

Performance	Outdoor LOS Range	3 miles using u.fl antenna .5 mile using on-board F antenna
	Transmit Power Output	up to +20 dBm
	RF Data Rate	250Kbps, 500Kbps, 1Mbps, 2Mbps
	Receiver Sensitivity	-103 dBm (1% PER, 250Kbps)
Power Requirements	Supply Voltage	2.0 - 3.6 V
	Transmit Current (Typ@3.3V)	at +20 dBm: 150 mA at +6 dBm: 55 mA
	Idle/Receive On (Typ@3.3V)	22 mA
	Idle/Receive Off (Typ@3.3V)	7.8 mA
	Sleep Mode Current (Typ@3.3V)	Timed Sleep: 1.27 μ A Untimed Sleep Mode : 390 nA
General	Frequency	ISM 2.4 GHz
	Spreading Method	Direct Sequence (DSSS)
	Modulation	O-QPSK
	Dimensions	29.8mm x 19mm
	Operating Temperature	- 40 to 85 deg C.
	Antenna Options	U.FL and on-board compact F antenna
	Weight	3 grams
Networking	Topology	SNAP
	Error Handling	Retries and acknowledgement
	Number of Channels	15 fully operational channels. To avoid exceeding FCC limits, channel 15 operates in a receive only state.
Available I/O	UARTS with optional HW Flow Control	2 Ports
	GPIO	32 total; 7 can be analog-in with 10bit ADC

Agency Approvals	FCC Part 15.247	FCC ID: U9O-SM220
	Industry Canada (IC)	7084A-SM220
	CE Certified	Certified to EN300 328 Version 1.8.1

SM220 Module Pin Definitions

For pin locations, consult the SM220 Mechanical drawing later in this document.

Table 2: SM220UF1 Pin Assignments

SM220 Pin	Pin Name	Pin Description
A1	GND	Power Supply
A2	VCC	Power Supply
A3	VCC	Power Supply
A4	PF0_ADC0	IO or Analog0
A5	PF2_ADC2_DIG2	IO or Analog2 or software SPI CLK ¹ or Antenna Diversity Control
A6	PF4_ADC4_TCK	IO or Analog4 or JTAG Test Clock
A7	PF6_ADC6_TDO	IO or Analog6 or JTAG Test Data Out or software I ² C ¹ SDA
A8	GND	Power Supply
B1	PE2_XCK0_AIN0	IO or software SPI ¹ MISO or Analog Comparator or External Clock
B2	PE3_OC3A_AIN1	IO or Analog Comparator or PWM or Output Compare Match
B3	PE5_OC3C_INT5	IO or UART0 RTS Input or PWM or Interrupt
B4	PF1_ADC1	IO or Analog1 or software SPI ¹ MOSI
B5	Test Point - Do Not Use	
B6	PF5_ADC5_TMS	IO or Analog5 or JTAG Test Mode Select
B7	PF7_ADC7_TDI	IO or Analog7 or JTAG Test Data In or software I ² C ¹ SCL
B8	GND	Power Supply
C1	PE0_RXD0_PDI_PCINT8	IO or UART0 Data In or Interrupt
C2	PE1_TXD0_PDO	IO or UART0 Data Out
C3	PE4_OC3B_INT4	IO or UART0 CTS Output or PWM or Interrupt

¹ Software generated SPI and I²C functions.

SM220 Pin	Pin Name	Pin Description
C4	PE6_T3_INT6	IO or Interrupt
C5	PE7_ICP3_INT7_CLK0	IO or UART1 RTS input or Clock Output Buffer or Interrupt
C6	NC	Test Point - Do not use
C7	NC	
C8	NC	Test Point - Do not use
D1	PB5_OC1A_PCINT5	IO or PWM or Interrupt
D2	PB6_OC1B_PCINT6	IO or PWM or Interrupt
D3	PB7_OC0A_OC1C_PCINT7	IO or PWM or Interrupt
D4	NC	
D5	NC	
D6	NC	
D7	NC	
D8	GND	Power Supply
E1	PB2_MOSI_PCINT2 ²	IO or Interrupt
E2	PB3_MISO_PCINT3 ²	IO or Interrupt
E3	PB4_OC2A_PCINT4	IO or PWM or Interrupt
E4	NC	
E5	NC	
E6	NC	
E7	NC	
E8	NC	
F1	PB0_SSN_PCINT0 ²	IO or Interrupt
F2	PB1_SCK_PCINT1 ²	IO or Interrupt
F3	PD1_SDA_INT1 ³	IO or Interrupt
F4	PD0_SCL_INT0 ³	IO or Interrupt

² These pins have special SPI hardware that is not natively supported by SNAP. You can use PEEK and POKE to initiate and enable this hardware functionality, but it is not supported by Synapse and we cannot guarantee your results.

³ These pins have special I²C hardware that is not natively supported by SNAP. You can use PEEK and POKE to initiate and enable this hardware functionality, but it is not supported by Synapse and we cannot guarantee your results.

SM220 Pin	Pin Name	Pin Description
F5	Test Point - Do Not Use	
F6	Test Point - Do Not Use	
F7	NC	
F8	GND	Power Supply
G1	CLKI	Must be pulled low during normal operation
G2	PD7_T0	IO
G3	PD4_ICP1	IO or UART1 CTS output or Input Capture
G4	PD2_RXD1_INT2	IO or UART1 Data In or Interrupt
G5	PG5_OC0B	IO or PWM
G6	NC	
G7	NC	
G8	GND	Power Supply
H1	GND	Power Supply
H2	PD6_T1	IO or Timer/Counter1 clock input
H3	PD5_XCK1	IO
H4	PD3_TXD1_INT3	IO or UART1 Data Out or Interrupt
H5	RESET#	Module Reset, Active Low
H6	NC	
H7	NC	
H8	GND	Power Supply

As a convenience, here is a cross reference from SM220 pad back to SNAPpy IO.

Table 3: SM220/SNAPpy IO Cross Reference

Pad	SNAPpy IO	Pad	SNAPpy IO
A4	24	D2	6
A5	26	D3	7
A6	28	E1	2
A7	30	E2	3
B1	18	E3	4
B2	19	F1	0
B3	21	F2	1
B4	25	F3	9
B6	29	F4	8
B7	31	G2	15
C1	16	G3	12
C2	17	G4	10
C3	20	G5	37
C4	22	H2	14
C5	23	H3	13
D1	5	H4	11

Electrical Characteristics

Unless otherwise specified in **Table 4**, all electrical characteristics conform to the Atmel ATmega 128RFA1 microcontroller. Detailed specifications on all electrical characteristics are available on the Atmel website at <http://www.atmel.com/>

Table 4: SM220 DC Characteristics at 25° C

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}^4	Supply Voltage		2.0	3.3	3.6	V

⁴ Absolute maximum stress rated voltage for VCC is -0.3 to 3.6. It is recommended that bulk capacitance be located as close as possible to the VCC pin on the host board. Ideally, use a single 47µF capacitor rated at 10V directly at the VCC pin.

Mechanical Drawings

Figure 1 and Figure 2 show the modules with the compact F antenna and U.FL Connector options.

NOTE: The area under the module's antenna (marked KEEP OUT AREA) should have no components, no traces, and no copper on any layer of the printed circuit board.

NOTE: For best performance, the module should be mounted on the outside edge of the circuit board with the antenna side as close to the edge of the board as possible.

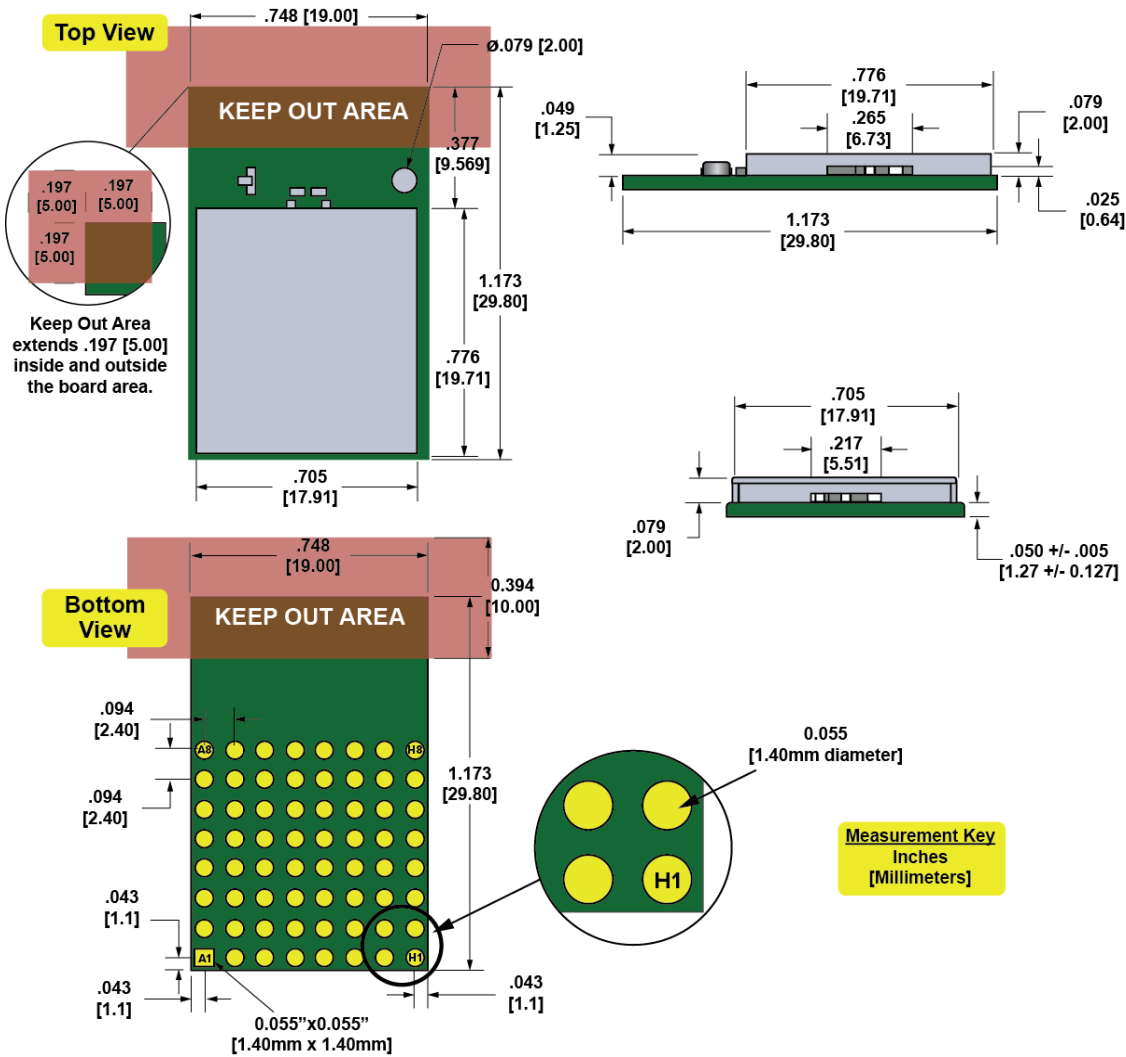


Figure 1: SM220UF1 Mechanical Drawing

NOTE: The area under the module's antenna (marked KEEP OUT AREA) should have no components, no traces, and no copper on any layer of the printed circuit board.

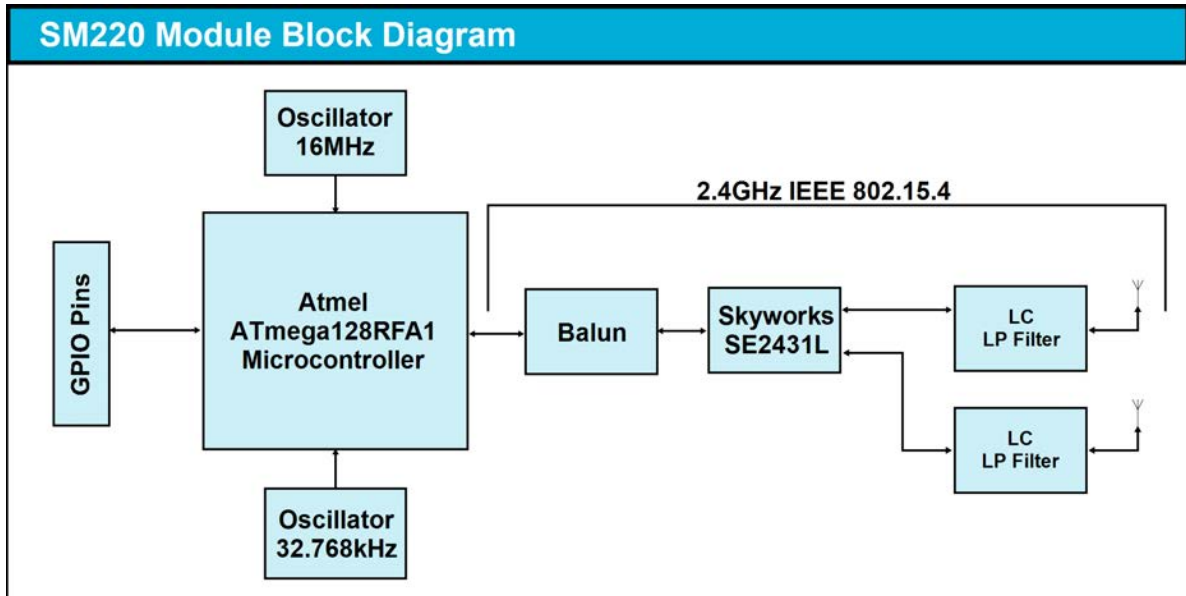


Figure 2: Block diagram showing the major subsystems comprising Model SM220

Selecting an Antenna

The SM220 uses the on-board compact F antenna by default. If you wish to use an external U.FL antenna with your application, you will need to set bit 0x0010 of NV ID 64 to 1. This is a one-time change that will persist through reboots and program changes. To revert to the on-board antenna, change bit 0x0010 of NV ID 64 back to 0.

Antenna Gain Performance

HyperLink Technologies HG2405RD-RSP

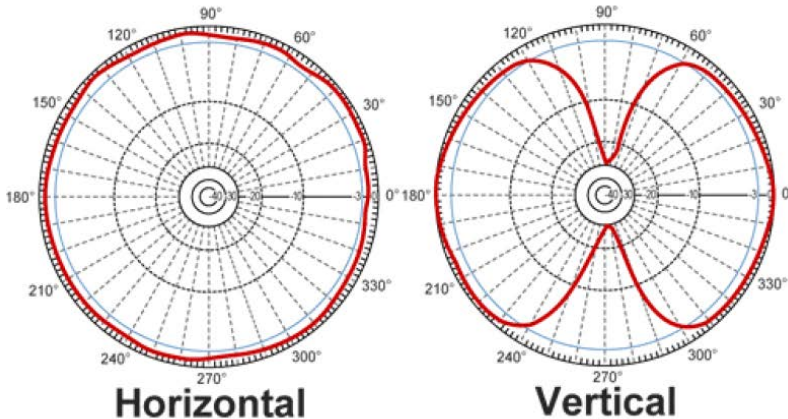
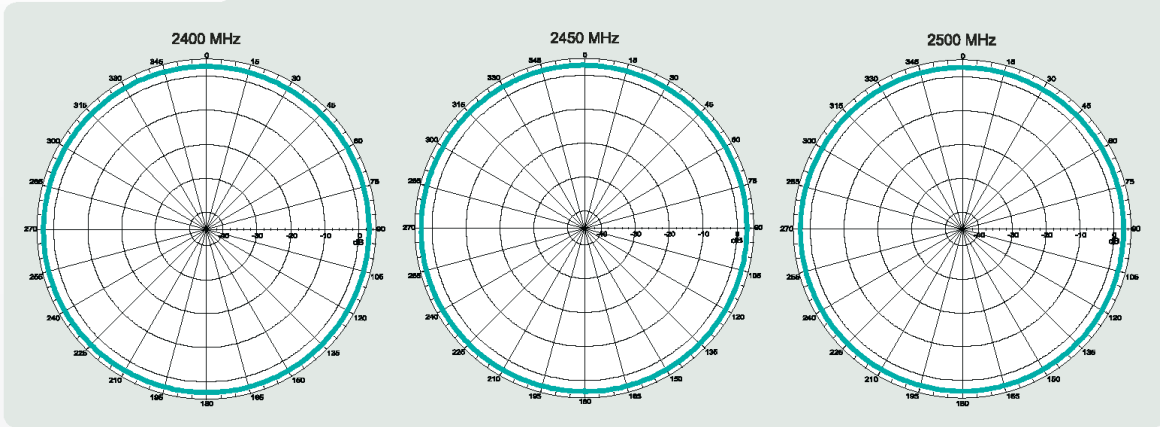


Figure 3: HyperLink Technologies HG2405RD-RSP Antenna Gain Performance

Pulse W107

Horizontal Position



Vertical Position

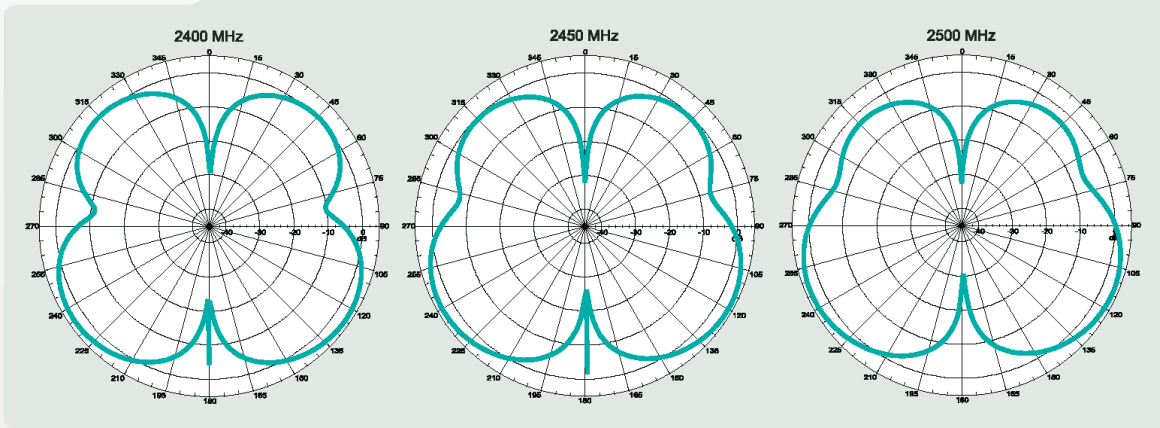


Figure 4: Pulse W107 Antenna Gain Performance

Board Mounting Considerations

Processing

Table 5: Recommended Reflow Profile

Parameter	Value
Ramp up rate (from Tsoakmax to Tpeak)	3°/sec max
Minimum Soak Temperature	150°C
Maximum Soak Temperature	200°C
Soak Time	60-120 sec

Parameter	Value
TLiquidus	217°C
Time above TL	30-60 sec (recommended: 40 sec)
Tpeak	230° - 250°C (recommended: 235°C)
Time within 5° of Tpeak	20-30 sec
Time from 25° to Tpeak	8 min max
Ramp down rate	6°C/sec max

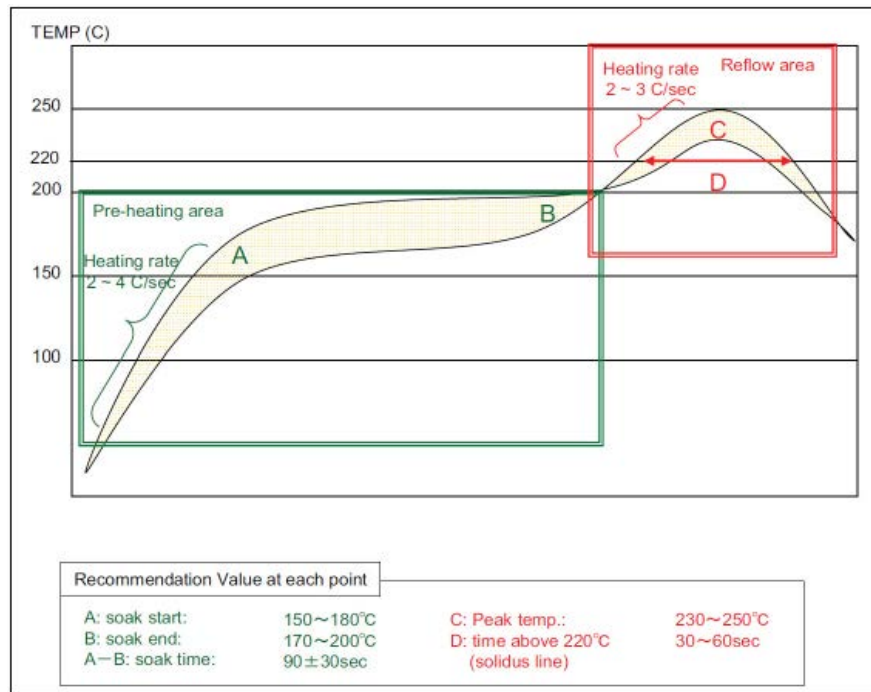


Figure 5: Reflow Profile Graph

Pb-Free Soldering Paste

Use of “No Clean” soldering paste is strongly recommended, as it does not require cleaning after the soldering process.

Cleaning

In general, cleaning the populated modules is strongly discouraged. Residuals under the module cannot be easily removed with any cleaning process.

- Cleaning with water can lead to capillary effects where water is absorbed into the gap between the host board and the module. The combination of soldering flux residuals and encapsulated water could lead to short circuits between neighboring pads. Water could also damage any stickers or labels.

- Cleaning with alcohol or a similar organic solvent will likely flood soldering flux residuals into the two housings, which is not accessible for post-washing inspection. The solvent could also damage any stickers or labels.
- Ultrasonic cleaning could damage the module permanently.

The recommended approach is to consider using a “no clean” soldering paste and eliminate the post-soldering cleaning step.

Repeating Reflow Soldering

Only a single reflow soldering process is encouraged for host boards.

Rework

The Model SM220 Module can be unsoldered from the host board, but the process is likely to damage the chip and not recommended. If attempting this, use of a hot air rework tool and hot plate for pre-heating from underneath is recommended. Avoid overheating.

WARNING!: Never attempt a rework on the module itself (e.g. replacing individual components). Such actions will terminate warranty coverage.

Additional Grounding

Attempts to improve module or system grounding by soldering braids, wires, or cables onto the module RF shield cover is done at the customer's own risk. The numerous ground pins at the module perimeter should be sufficient for optimum immunity to external RF interference.

Agency Certifications

United States (FCC)

The Model SM220 modules comply with Part 15 of the FCC rules and regulations. Compliance with the labeling requirements, FCC notices, and antenna usage guidelines is required. In order to comply with FCC Certification requirements, the Original Equipment Manufacturer (OEM) must fulfill the following requirements.

1. The system integrator must place an exterior label on the outside of the final product housing the SM220 Modules. **Figure 6** below shows the contents that must be included on this label.
2. SM220 Modules may only be used with the antenna that has been tested and approved for use with the module. Please refer to the antenna table provided in this section.

OEM Labeling Requirements

NOTICE: The OEM must make sure that FCC labeling requirements are met. This includes a clearly visible exterior label on the outside of the final product housing that displays the contents shown in **Figure 6** below.

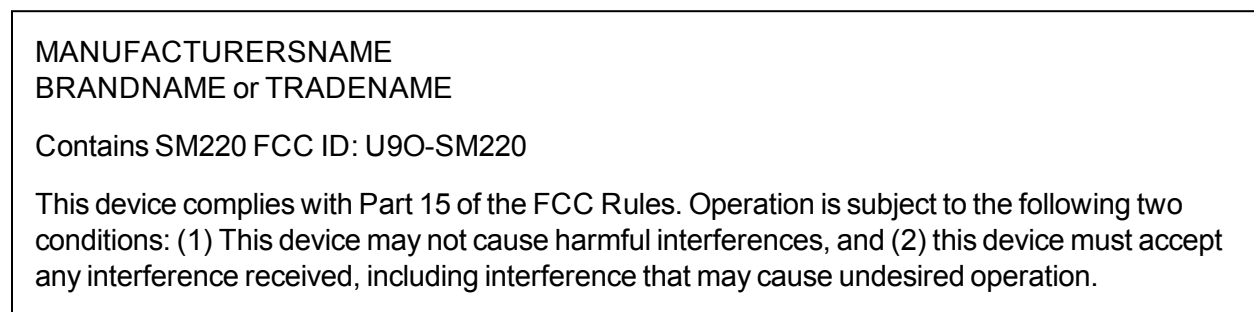


Figure 6: FCC Label

FCC Notices

WARNING!: The SM220 modules have been tested by the FCC for use with other products without further certification (as per FCC Section 2.1091). Changes or modifications to this device not expressly approved by Synapse Wireless Inc. could void the user's authority to operate the equipment.

NOTICE: OEM's must certify final end product to comply with unintentional radiators (FCC Sections 15.107 and 15.109) before declaring compliance of their final product to Part 15 of the FCC Rules.

NOTICE: The SM220 modules have been certified for remote and base radio applications. If the module will be used for portable applications as defined by the FCC, the device must undergo SAR testing.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

FCC Approved Antennas

The SM220 modules are FCC-approved for fixed base station and mobile applications.

Notice: To reduce potential radio interference to other users, the antenna type and its gain should be chosen so that the equivalent isotropically radiated power (EIRP) is not more than that permitted for successful communication. This module has been designed to operate with the antennas listed in **Table 6** and **Table 7** below. The required antenna impedance is 50 ohms.

Table 6: SM220UF1 Approved FCC Antennas

Part Number	Type	Gain	Impedance	Application	Min. Separation
Compact F Antenna	PC Board Trace Antenna	0.0 dBi	50Ω	Fixed/Mobile	20 cm.

Table 7: SM220UF1 Approved FCC Antennas

Part Number	Type	Gain	Impedance	Application	Min. Separation
Pulse W1027	Dipole (quarter-wave RPSMA)	3.2 dBi	50Ω	Fixed/Mobile	20 cm.
HyperLink HG2405RD-RSP	Dipole (quarter-wave RPSMA)	5.5 dBi	50Ω	Fixed/Mobile	20 cm.

For more information on approved antennas, please consult the manufacturer's website.

WARNING!: RF Exposure: This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20 cm between the radiator and your body. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

NOTICE: The preceding statement must be included as a CAUTION statement in OEM product manuals in order to alert users of FCC RF exposure compliance.

NOTE: Antenna and transmitters may be co-located or operated in conjunction with this device only if the transmitters do not simultaneously transmit. Otherwise, additional regulatory requirements will apply.

Canada (IC)

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (EIRP) is not more than that necessary for successful communication.

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la

puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

This radio transmitter Model: SM220, IC: 7084A-SM220 has been approved by Industry Canada to operate with the antenna types listed below with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Le présent émetteur radio Model : SM220, IC : 7084A-SM220 a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés ci-dessous et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

Table 8: SM220UF1 Approved IC Antennas

Part Number	Type	Gain	Application	Min. Separation
Compact F Antenna	PC Board Trace Antenna	0.0 dBi	Fixed/Mobile	20 cm.

Table 9: SM220UF1 Approved IC Antennas

Part Number	Type	Gain	Application	Min. Separation
Pulse W1027	Dipole (quarter-wave RPSMA)	3.2 dBi	Fixed/Mobile	20 cm.
HyperLink HG2405RD-RSP	Dipole (quarter-wave RPSMA)	5.5 dBi	Fixed/Mobile	20 cm.

OEM Labeling Requirements

Labeling requirements for Industry Canada are similar to those of the FCC. A clearly visible label on the outside of the final product housing must display the contents shown in **Figure 7** below.

MANUFACTURERSNAME BRANDNAME or TRADENAME MODEL: Contains SM220 IC: 7084A-SM220

Figure 7: IC Label

NOTE: The OEM can choose to implement a single label combined for both FCC and IC labeling requirements. If a combined single label is chosen, there must be a clearly visible label on the outside of the final product housing displaying the contents shown in **Figure 8** below.

MANUFACTURERSNAME
BRANDNAME or TRADENAME

Contains SM220 FCC ID: U9O-SM220
Contains SM220 IC: 7084A-SM220

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interferences, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Figure 8: Combined FCC and IC Label

OEM Labeling Requirements for the European Union

The “CE” mark must be placed on the OEM product in a visible location. The CE mark will consist of the Initials “CE” with the following form:

If the CE marking is reduced or enlarged, the proportions given in the following drawing must be adhered to.

The CE mark must be a minimum of 5mm in height.

The CE marking must be affixed visibly, legibly, and indelibly.

Since the 2400-2483.5 MHz band is not harmonized by a few countries throughout Europe, the Restriction sign must be placed to the right of the CE marking as shown in the drawing.



NOTE: The OEM can choose to implement a single label combined for FCC, CE and IC labeling requirements. If a combined single label is chosen, there must be a clearly visible label on the outside of the final product housing displaying the contents shown in **Figure 9**.

MANUFACTURERSNAME
BRANDNAME or TRADENAME

Contains SM220 FCC ID: U9O-SM220

Contains SM220 IC: 7084A-SM220

CE

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interferences, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Figure 9: Combined FCC, CE and IC Label